

•General Description

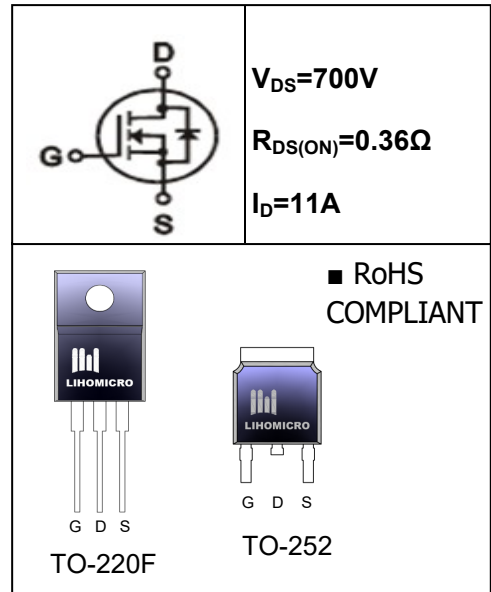
The SJ MOSFET LH70R360 has the low $R_{DS(on)}$, low gate charge, fast switching and excellent avalanche characteristics. This device offers extremely fast and robust body diode, and is suitable for telecom and power supplies.

•Features

- Much lower $R_{on} \cdot A$ performance for On-state efficiency
- Much lower FOM for fast switching efficiency

•Application

- LED/LCD/PDP TV and monitor Lighting
- Solar/Renewable/UPS-Micro Inverter System
- Power Supplies


•Ordering Information:

Part number	LH70R360	LH70R360
Package	TO-252	TO-220F
Basic ordering unit (pcs)	2500	1000
Normal Package Material Ordering Code	LH70R360T5-T0252-TAP	LH70R360F-T0220F-TU
Halogen Free Ordering Code	LH70R360T5-T0252-TAP-HF	LH70R360F-T0220F-TU-HF

•Absolute Maximum Ratings (TC =25°C)

PARAMETER		SYMBOL	Value		UNIT
Drain-Source Breakdown Voltage		BV _{DSS}	700		V
Gate-Source Voltage		V _{GS}	±30		V
Continuous Drain Current	TC = 25°C	I _D	11		A
	TC = 100°C		6.6		
Pulsed drain current (TC = 25°C, tp limited by Tjmax) ¹		I _D pulse	33		A
Single Pulse Avalanche Energy		I _{AR}	1.8		A
Single Pulse Avalanche Energy ²		E _{AS}	215		mJ
Repetitive Avalanche Energy ²		E _{AR}	0.32		mJ
Power Dissipation(TC=25°C)		P _D	TO-252: 82	TO-220F: 31	W
Operating Temperature and Storage Temperature Range		T _J /T _{STG}	-55~+150		°C
Reverse diode dv/dt ³		dv/dt	15		V/ns
Maximum diode commutation speed ³		di _t /dt	500		V/ns

●Electronic Characteristics

PARAMETER	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	700	--	--	V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.5	--	4.5	V
Drain-source On Resistance ³	$R_{DS(ON)}$	$V_{GS}=10V, I_D=5.5V$	--	0.31	0.36	Ω
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=700V, V_{GS}=0V, T_J=25^\circ C$	--	--	1	μA
		$V_{DS}=700V, V_{GS}=0V, T_J=125^\circ C$	--	--	100	
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 30$	--	--	± 100	nA
Forward Transconductance ³	R_G	$f=1.0MHz$ open drain	--	--	18	Ω
Input Capacitance	C_{iss}	$V_{GS}=0V,$ $V_{DS}=60V$ $f=1.0MHz$	--	828	--	pF
Output Capacitance	C_{oss}		--	728	--	
Reverse transfer Capacitance	C_{rss}		--	38	--	
Turn -Off Delay Time	$T_d(off)$	$V_{DD}=400V,$ $I_D=11.0A$ $R_G=25\Omega$	--	145	--	ns
Turn-on delay time	$T_d(on)$		--	18	--	
Rise time	T_r		--	40	--	
Fall time	T_f		--	39	--	
Total Gate Charge	Q_g	$I_D=11A,$ $V_{DS}=520V$ $V_{GS}=10V$	--	22	---	nC
Gate-to-Source Charge	Q_{gs}		--	4.8	--	
Gate-to-Drain Charge	Q_{gd}		--	8	---	
Continuous Diode Forward Current	I_S		--	--	11	A
Pulsed Diode Forward Current ¹	I_{SM}		--	--	33	A
Diode Forward Voltage	V_{SD}	$T_J=25^\circ C, I_S=5.5A$ $V_{GS}=0V$	--	0.9	1.2	V
Reverse Recovery Time	t_{rr}	$V_{RR}=400V,$ $I_f=I_S$ $di_F/dt=100A/\mu s$	--	327	--	ns
Reverse Recovery Charge	Q_{rr}		--	3.4	--	μC
Peak Reverse Recovery Current	I_{RRM}		--	17.8	--	A

●Thermal Characteristics

PARAMETER	SYMBOL	MAX		UNIT
		TO-252	TO-220F	
Thermal Resistance Junction-case	R_{thJC}	1.51	4	$^\circ C/W$
Thermal Resistance Junction-ambient	R_{thJA}	62	80	$^\circ C/W$

Notes:

1.Repetitive Rating: Pulse width limited by maximum junction temperature.

2. $I_{AS}=1.8A, V_{DD}=50V, R_G=25\Omega$, Starting $T_J=25^\circ C$

3. Pulse Test : Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$

● **Typical Characteristics** $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

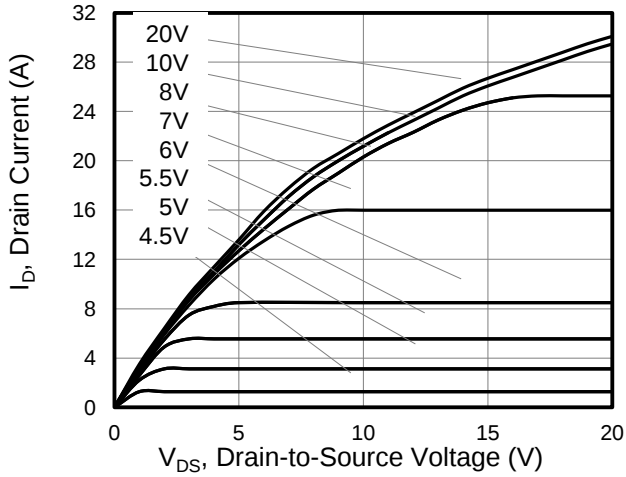


Figure 2. Transfer Characteristics

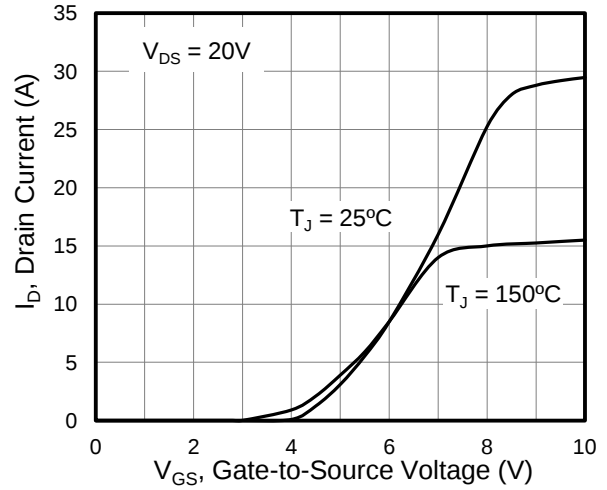


Figure 3. On-Resistance vs. Drain Current

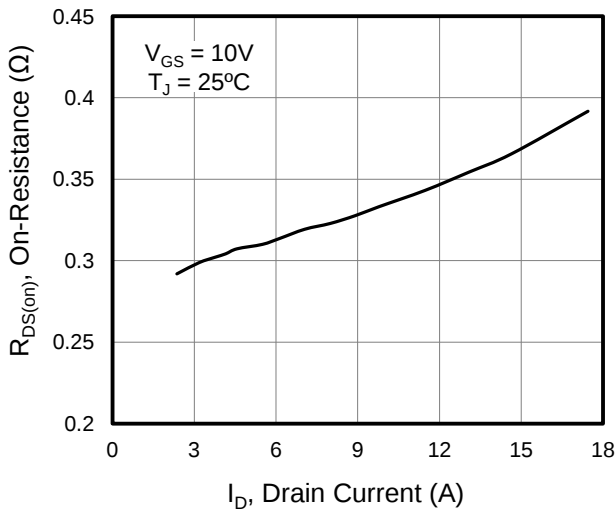


Figure 4. Capacitance

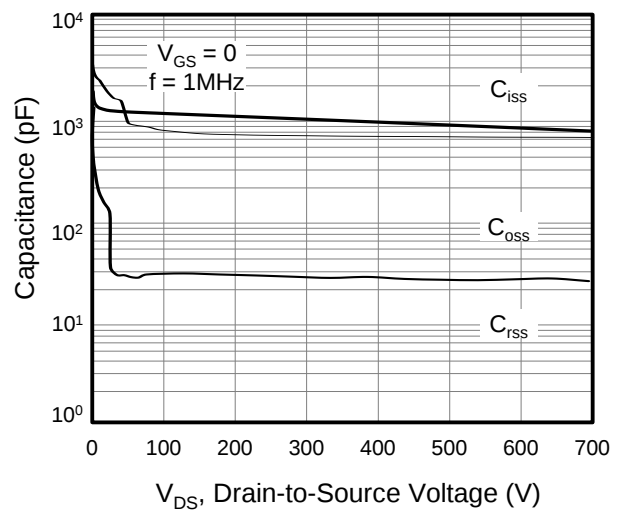


Figure 5. Gate Charge

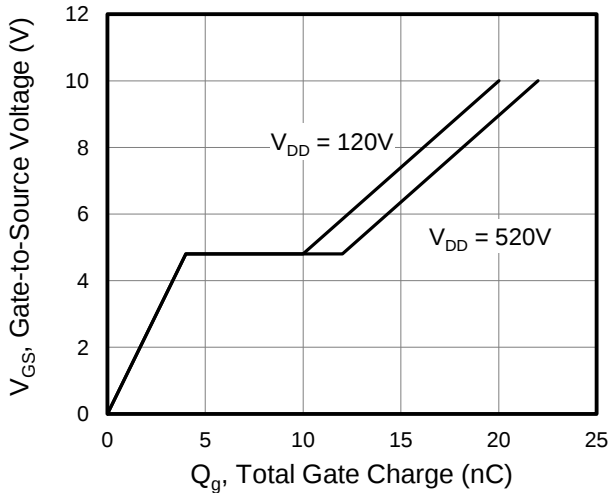
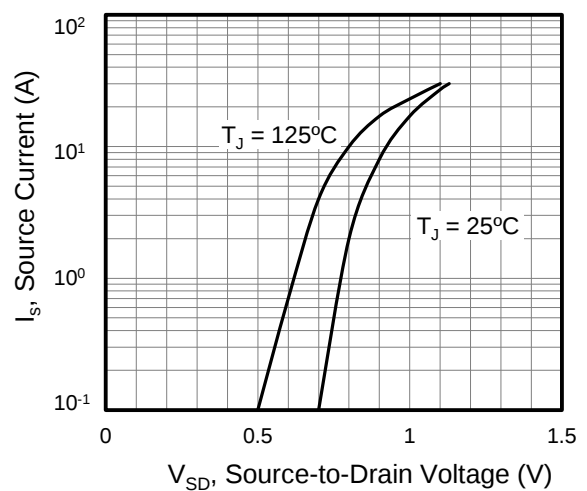


Figure 6. Body Diode Forward Voltage



•Typical Characteristics(Cont.)

Figure 7. On-Resistance vs. Junction Temperature

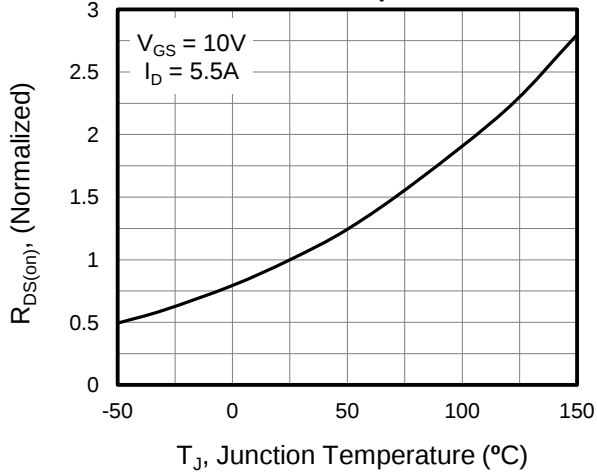


Figure 8. Breakdown voltage vs. Junction Temperature

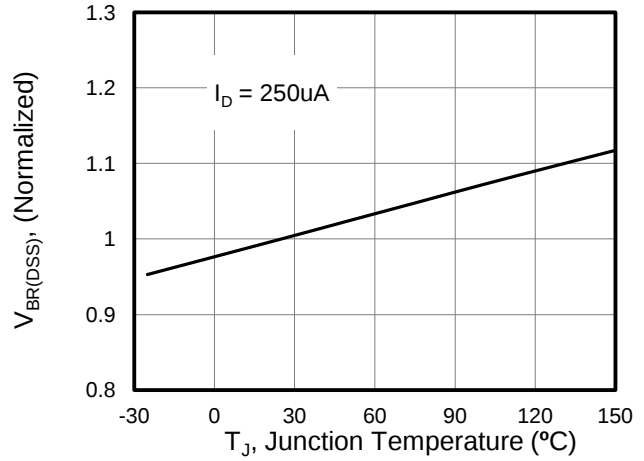


Figure 9. Transient Thermal Impedance

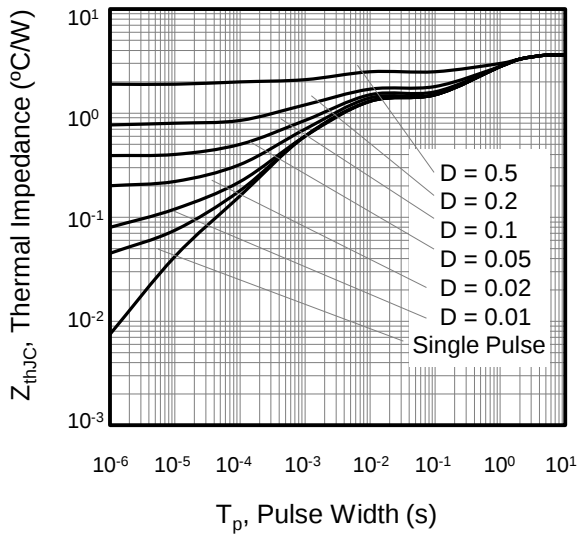
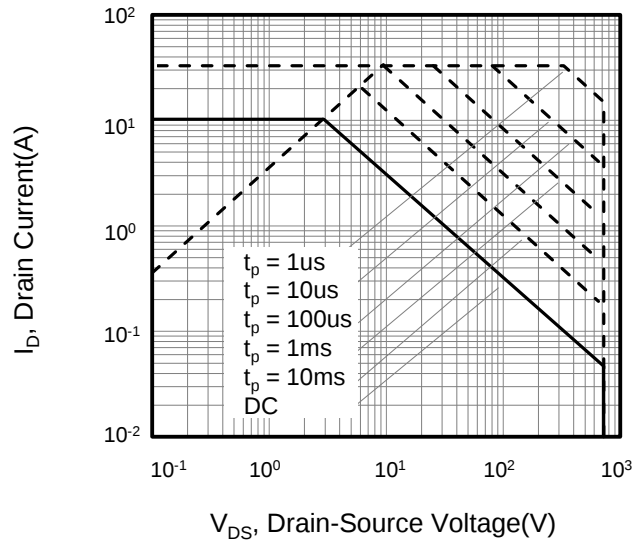


Figure 10. Safe operation area



• **Test Circuit and Waveforms**

Figure A: Gate Charge Test Circuit and Waveform

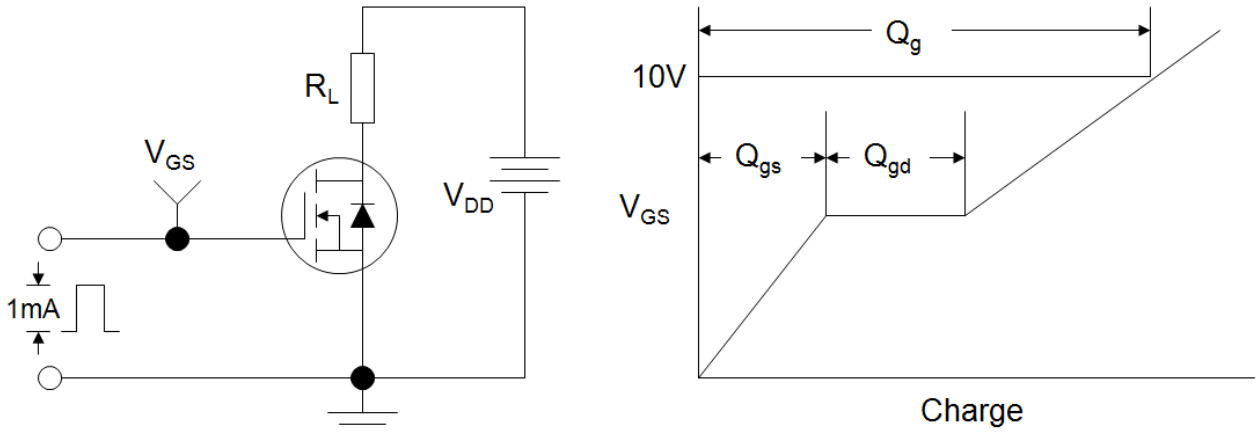


Figure B: Resistive Switching Test Circuit and Waveform

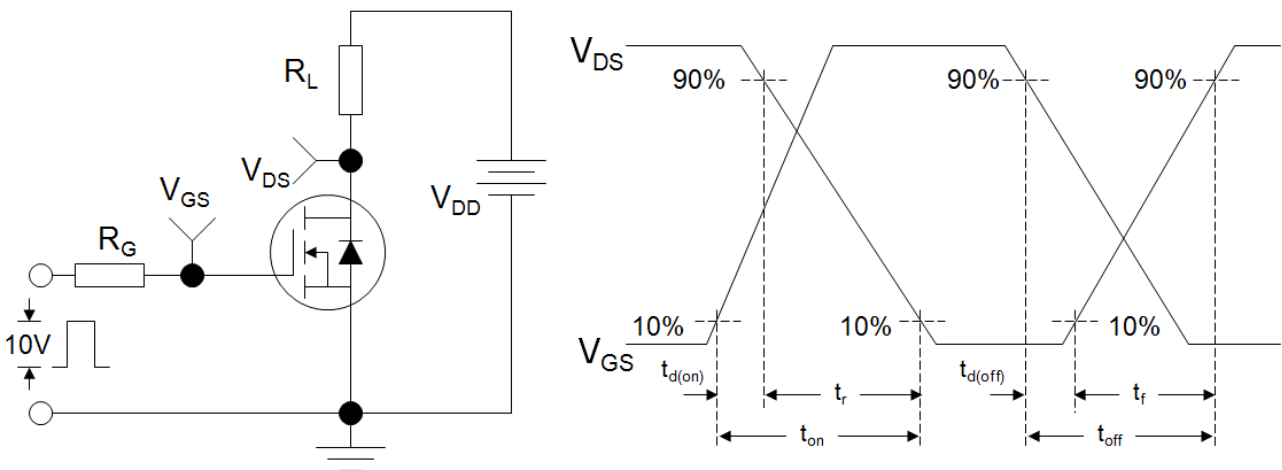
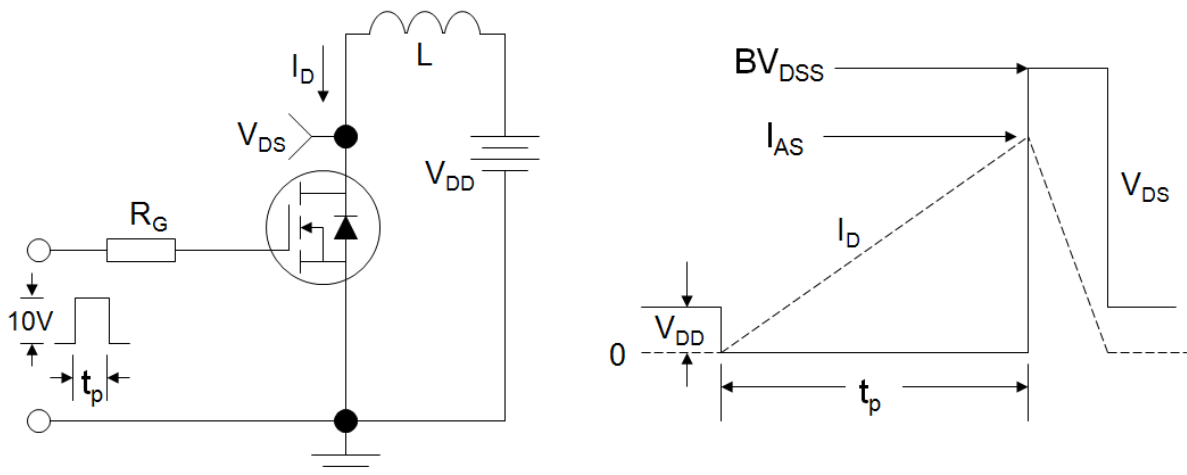


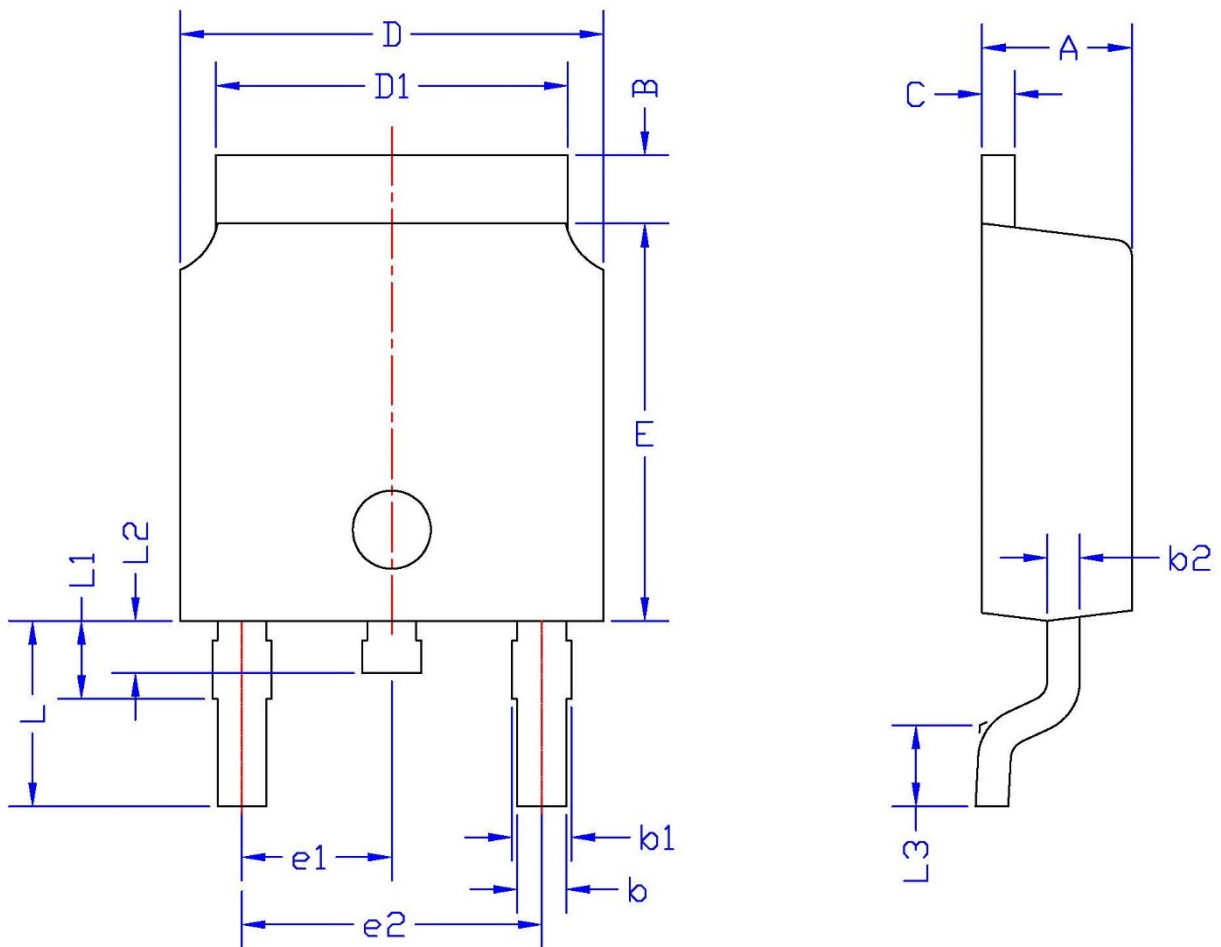
Figure C: Unclamped Inductive Switching Test Circuit and Waveform



●Dimensions (TO-252)

UNIT:mm

SYMBOL	min	max	SYMBOL	min	max
A	2.10	2.50	L2	0.60	1.20
b	0.50	0.90	L3	1.20	1.80
b1	0.70	1.20	B	0.80	1.30
b2	0.40	0.70	C	0.40	0.70
D	6.20	6.80	D1	5.10	5.60
E	5.80	6.40	e1	2.10	2.45
L	2.60	3.60	e2	4.40	4.80
L1	0.80	1.60			



●Dimensions (TO-220F)

UNIT:mm

SYMBOL	min	max	SYMBOL	min	max
A	4.20	4.80	E1	8.30	8.70
A1	2.50	2.90	e	2.40	2.70
A2	2.90	3.30	e1	4.95	5.25
b	0.40	0.80	F	2.50	2.90
b1	1.10	1.50	L	13.00	14.00
c	0.50	0.70	L1	3.00	4.00
D	9.80	10.60	∅P	2.90	3.50
E	14.60	15.60			

